

## **STPS0530Z**

## Schottky rectifiers

### Main product characteristics

I <sub>F(AV)</sub>	0.5 A
V <sub>RRM</sub>	30 V
V <sub>F</sub> (max)	0.33 V

### Features and benefits

- Very small conduction losses
- Negligible switching losses
- Extremely fast switching

### **Description**

Single Schottky rectifier suited for switch mode power supplies and high frequency DC to DC converters.

Packaged in SOD-123, this device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications. Due to the small size of the package this device fits GSM and PCMCIA requirements.



### Order code

Order code	Marking
STPS0503Z	Z53

Table 1. Absolute ratings (limiting values)

Symbol	Paramet	Value	Unit	
V <sub>RRM</sub>	Repetitive peak reverse voltage	30	V	
I <sub>F(RMS)</sub>	RMS forward current	2	Α	
I <sub>F(AV)</sub>	Average forward current $\delta = 0.5$ $T_a = 55^{\circ} C$		0.5	Α
I <sub>FSM</sub>	Surge non repetitive forward current	5.5	Α	
dV/dt	Critical rate of rise of reverse voltage		10000	V/µs
T <sub>stg</sub>	Storage temperature range	-65 to + 150	°C	
T <sub>j</sub>	Maximum operating junction temperatur	150	°C	
T <sub>L</sub>	Maximum temperature for soldering during 10 s		260	°C

<sup>1.</sup>  $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

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Table 2. Thermal resistance

S	ymbol	Parameter	Value	Unit
F	R <sub>th(j-a)</sub>	Junction to ambient	340 <sup>(1)</sup>	°C/W

<sup>1.</sup> Copper area on PCB  $S = 2.5 \text{ mm}^2$ 

Table 3. Static electrical characteristics

				Value		
Symbol	Symbol Parameter Test conditions		Test conditions STI		STPS0530Z	
			Тур.	Max.		
		T <sub>j</sub> = 25° C	V = 15 V		12	μΑ
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage current	T <sub>j</sub> = 125° C	V <sub>R</sub> = 15 V	3	5	mA
'R`		T <sub>j</sub> = 25° C	V <sub>R</sub> = V <sub>RRM</sub>		130	μA
		T <sub>j</sub> = 125° C		9	21	mA
	Forward voltage drop	T <sub>j</sub> = 25° C	I <sub>F</sub> = 0.1 A		0.375	
V <sub>F</sub> <sup>(2)</sup>		T <sub>j</sub> = 125° C	1 IF = 0.1 A	0.20	0.22	V
		T <sub>j</sub> = 25° C	I <sub>F</sub> = 0.5 A		0.43	
		T <sub>j</sub> = 125° C	IF = 0.5 A	0.31	0.33	

<sup>1.</sup> Pulse test:  $tp = 5 \text{ ms}, \delta < 2\%$ 

To evaluate the maximum conduction losses use the following equation: P = 0.23 x  $\rm I_{F(AV)}$  + 0.18  $\rm I_{F}^2_{(RMS)}$ 

$$P = 0.23 \text{ x } I_{F(AV)} + 0.18 I_{F^{2}(RMS)}$$

<sup>2.</sup> Pulse test: tp = 380  $\mu$ s,  $\delta$  < 2%

STPS0530Z Characteristics

Figure 1. Conduction losses versus average Figure 2. Average forward current versus ambient temperature ( $\delta$  = 0.5)

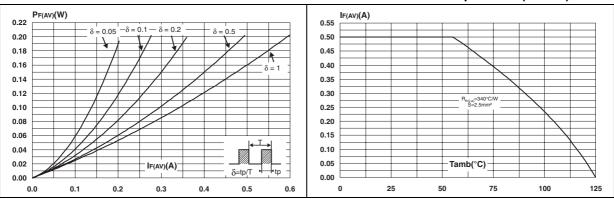


Figure 3. Non repetitive surge peak forward current versus overload duration (maximum values)

Figure 4. Relative variation of thermal impedance junction to ambient versus pulse duration

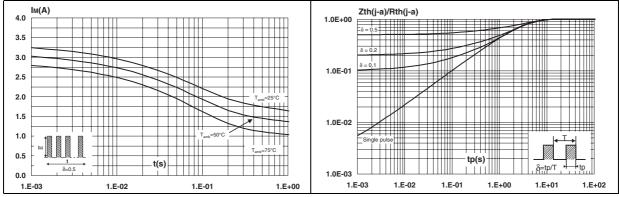
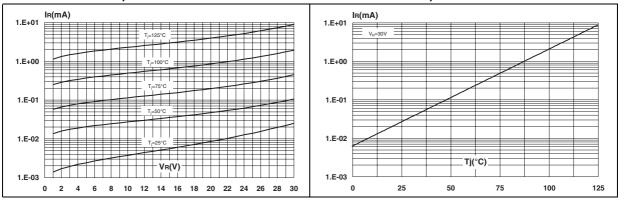


Figure 5. Reverse leakage current versus reverse voltage applied (typical values)

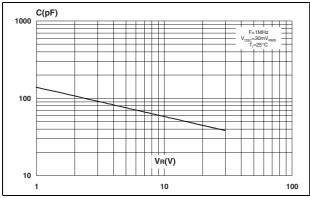
Figure 6. Reverse leakage current versus junction temperature (typical values)



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Figure 7. Junction capacitance versus reverse voltage applied (typical values)

Figure 8. Forward voltage drop versus forward current



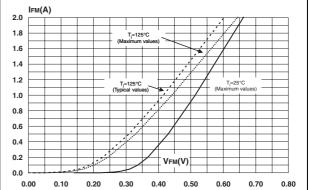
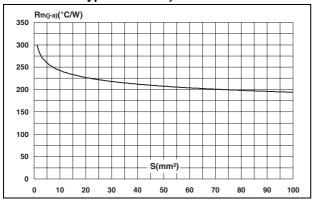


Figure 9. Thermal resistance junction to ambient versus copper surface under each lead (epoxy printed circuit board FR4, Cu = 35  $\mu$ m, typical values)



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STPS0530Z Package information

## 2 Package information

- Epoxy meets UL94, V0.
- Band indicates cathode.

Table 4. SOD-123 dimensions

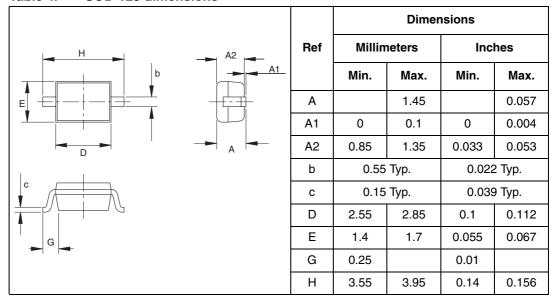
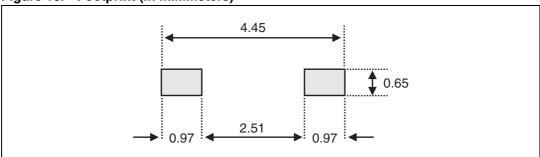


Figure 10. Footprint (in millimeters)



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Ordering information STPS0530Z

# 3 Ordering information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS0530Z Z53		SOD-123	0.01 g	3000	Tape & reel

# 4 Revision history

Date	Revision	Changes
Mar-2003	1A	Initial release.
17-Oct-2006	2	Reformated to current standards. Updated maximum junction temperatures to 150° C and updated package illustration to show cathode bar on page 1

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